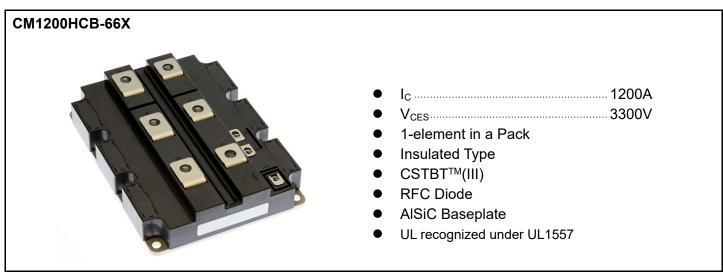


< High Voltage Insulated Gate Bipolar Transistor: HVIGBT >

CM1200HCB-66X

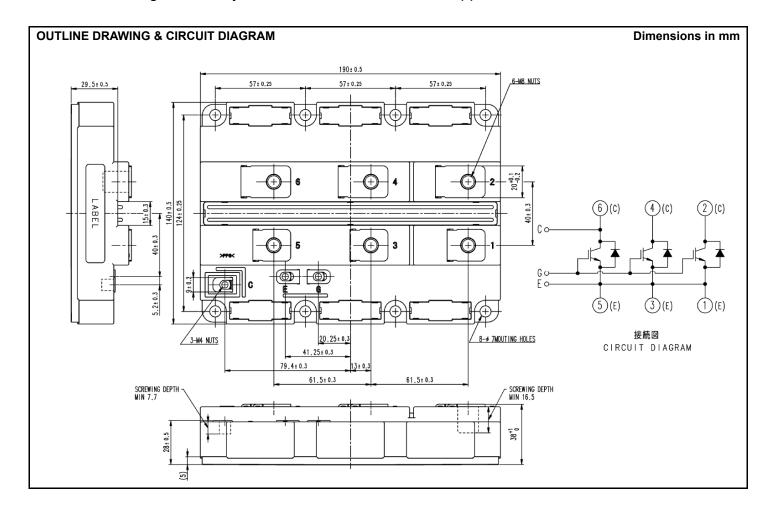
HIGH POWER SWITCHING USE INSULATED TYPE

5th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules



APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers



< High Voltage Insulated Gate Bipolar Transistor : HVIGBT >

CM1200HCB-66X HIGH POWER SWITCHING USE INSULATED TYPE

5th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
V	Callantan amittan waltan	$V_{GE} = 0V, T_j = -40+150$ °C	3300	
V _{CES}	Collector-emitter voltage	$V_{GE} = 0V, T_{j} = -50^{\circ}C$	3200	V
V_{GES}	Gate-emitter voltage	$V_{CE} = 0V, T_j = 25^{\circ}C$	±20	V
Ic	Callantan assumant	DC, T _c = 105°C	1200	Α
I _{CRM}	Collector current	Pulse (Note 1)	2400	Α
I _E	Emitter current (Note 2)	DC, $T_c = 90$ °C	1200	Α
I _{ERM}	Emiller current	Pulse (Note 1)	2400	Α
P _{tot}	Maximum power dissipation (Note 3)	T _c = 25°C, IGBT part	11900	W
V _{iso}	Isolation voltage	RMS, sinusoidal, f = 60Hz, t = 1 min.	6000	V
V _e	Partial discharge extinction voltage	RMS, sinusoidal, f = 60Hz, Q _{PD} ≤ 10 pC	2600	V
T _i	Junction temperature		−50 ~ +150	°C
T _{jop}	Operating junction temperature		−50 ~ +150	°C
T _{stg}	Storage temperature		− 55 ~ + 150	°C
t _{psc}	Short circuit pulse width	$V_{CC} = 2500V, V_{CE} \le V_{CES}, V_{GE} = 15V, T_j = 150^{\circ}C$	10	μs

ELECTRICAL CHARACTERISTICS

Symbol	Item	Item Conditions			Limits		Unit
Cymbol	item			Min	Тур	Max	01111
I _{CES}			T _j = 25°C			4.0	
	Collector cutoff current	$V_{CE} = V_{CES}, V_{GE} = 0V$	T _j = 125°C	_	4.0		mA
			T _i = 150°C		24.0	_	
$V_{GE(th)}$	Gate-emitter threshold voltage	$V_{CE} = 10 \text{ V}, I_{C} = 120 \text{ mA}, T_{j} = 25^{\circ}\text{C}$		6.5	7.0	7.5	V
I_{GES}	Gate leakage current	$V_{GE} = V_{GES}$, $V_{CE} = 0V$, $T_j = 25$ °C		-0.5	_	0.5	μA
C _{ies}	Input capacitance	V _{CE} = 10 V, V _{GE} = 0 V, f = 100 kHz	,		139	_	
Coes	Output capacitance	$T_i = 25^{\circ}C$	-		9.3	_	nF
C _{res}	Reverse transfer capacitance	1) 20 0		_	1.3	_	
Q_G	Total gate charge	V_{CC} = 1800V, I_{C} = 1200A, V_{GE} = ±	15V	_	9.0		μC
		I _C = 1200A (Note 4)	T _j = 25°C	_	2.00	_	V
V_{CEsat}	Collector-emitter saturation voltage	$V_{GE} = 15V$	$T_j = 125^{\circ}C$		2.50	_	
		V GE - 13 V	$T_{j} = 150^{\circ}C$	_	2.60	3.10	
t _{d(on)}	Turn-on delay time		T _j = 150°C	_	_	0.90	μs
t _r	Turn-on rise time	V _{CC} = 1800V	T _j = 150°C	-	_	0.50	μs
	Turn-on switching energy (Note 7) (per pulse)	I _C = 1200A	T _j = 25°C	_	1.95	_	J
E _{on(10%)}		$V_{GE} = \pm 15V$	T _j = 125°C	_	2.15	_	
		$R_{G(on)} = 2.2 \Omega$	T _j = 150°C	_	2.25	_	
	Turn-on switching energy (Note 5) (per pulse)	L _s = 150nH	$T_j = 25^{\circ}C$	_	2.00	_	
E _{on}			T _j = 125°C	_	2.25	_	
			T _j = 150°C		2.35	_	
	Turn-off delay time		$T_j = 25^{\circ}C$	_	2.90	_	μs
$t_{d(off)}$			T _j = 125°C	_	3.20	_	
			T _j = 150°C		3.20	4.25	
	Turn-off fall time	V _{CC} = 1800V	$T_j = 25^{\circ}C$	_	0.40	_	
t _f		I _C = 1200A	T _j = 125°C	_	0.45	_	μs
		V _{GE} = ±15V	T _j = 150°C	_	0.50	1.00	
E _{off(10%)}	Turn-off switching energy (Note 7) (per pulse)	$R_{G(off)} = 18 \Omega$	T _j = 25°C	-	1.55	_	
		L _s = 150nH	T _j = 125°C		2.00	_	J
	(hei haise)	Inductive load	T _j = 150°C	_	2.05	_	
	Turn-off switching energy (Note 5)		T _j = 25°C		1.65	_	<u> </u>
E _{off}	Turn-off switching energy (Note 5) (per pulse)		T _j = 125°C	_	2.10	_	J
	(per puise)		T _j = 150°C	-	2.25	_	

< High Voltage Insulated Gate Bipolar Transistor : HVIGBT >

CM1200HCB-66X HIGH POWER SWITCHING USE INSULATED TYPE

5th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

ELECTRICAL CHARACTERISTICS (continuation)

Cymhal	Item		Conditions		Limits			Unit
Symbol					Min	Тур	Max	Offic
			I _E = 1200 A ^(Note 4)	T _j = 25°C		2.20	_	
V_{EC}	Emitter-collector voltage	(Note 2)		T _j = 125°C	_	2.40	_	V
			$V_{GE} = 0 V$	T _j = 150°C	_	2.50	3.00	
				T _j = 25°C	-	0.95	_	
t _{rr}	Reverse recovery time	(Note 2)		T _j = 125°C	1	1.10	_	μs
				T _j = 150°C	1	1.15	_	'
				T _j = 25°C	1	_	_	
Irr	Reverse recovery current	(Note 2)		T _j = 125°C	1	1550	_	Α
				T _j = 150°C	1	1650	_	
			V _{CC} = 1800 V	$T_j = 25^{\circ}C$		1050	_	
Q _{rr(10%)}	Reverse recovery charge	(Note 2,6)	I _C = 1200 A	T _j = 125°C		1600	_	μC
			V _{GE} = ±15 V	T _j = 150°C		1650	_	
			$R_{G(on)} = 2.2 \Omega$	T _j = 25°C	1	1200	_	
Q_{rr}	Reverse recovery charge	(Note 2,5)	L _s = 150 nH	T _j = 125°C	_	1750	_	μC
		Inductive load	T _j = 150°C	1	1800	_		
	(Note 2.7	(Note 2,7)		T _j = 25°C	1	1.15	_	
E _{rec(10%)}	Reverse recovery energy	····		T _j = 125°C		1.65	_	J
•	(per pulse)			T _j = 150°C		1.85	_	
	(Note 2.5)	(Note 2,5)		T _i = 25°C		1.25	_	
E _{rec}	Reverse recovery energy	(.1010 2,0)		T _i = 125°C		1.75	_	J
	(per pulse)			T _j = 150°C	_	1.95	_	

THERMAL CHARACTERISTICS

Cumbal	Item	Conditions	Limits			l lmi4
Symbol			Min	Тур	Max	Unit
$R_{th(j-c)Q}$	Thermal resistance	Junction to Case, IGBT part	-		10.5	K/kW
$R_{th(j-c)D}$		Junction to Case, FWDi part	-		16.5	K/kW
R _{th(c-s)}	Contact thermal resistance	Case to heat sink λ_{grease} = 1W/m*k, $D_{(c-s)}$ = 80 μ m		5.7	_	K/kW

MECHANICAL CHARACTERISTICS

Symbol	Item	Conditions		Unit		
		Conditions	Min	Тур	Max	Unit
M_t	Mounting torque	M8 : Main terminals screw	7.0	_	19.0	N·m
Ms	Mounting torque	M6 : Mounting screw	3.0	_	6.0	N·m
M_t	Mounting torque (Note 8)	M4 : Auxiliary terminals screw	1.0	_	3.0	N·m
М	Mass		_	1.2	_	kg
CTI	Comparative tracking index		600	_	_	_
da	Clearance		19.5	_	_	mm
d _s	Creepage distance		32.0	_	_	mm
L _{P CE}	Parasitic stray inductance		_	8.0	_	nΗ
R _{CC'+EE'}	Internal lead resistance	T _C = 25°C	_	0.09	_	mΩ

Note1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{jopmax} rating.

Note2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD_i).

Note3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).

Note4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

Note5. Definition of all items is according to IEC 60747, unless otherwise specified.

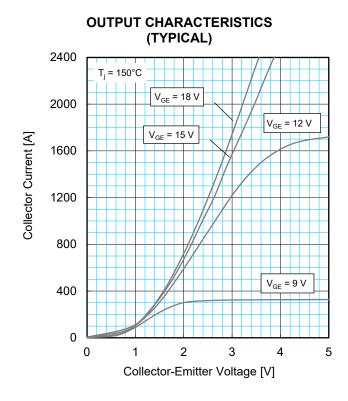
Note6. The integration range of reverse recovery charge is from I_E = 0A to 10% I_E .

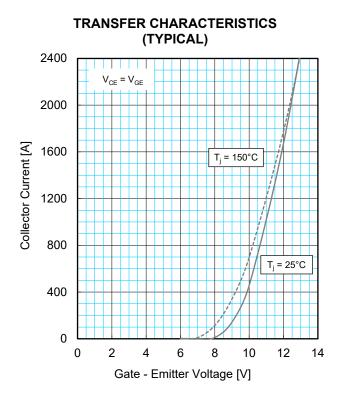
Note7. The integration range of switching energies is from 10%V_{CE} to 10%I_c(10%I_E).

Note8. The maximum specified value is under the condition of using PCB mounted on the power module.

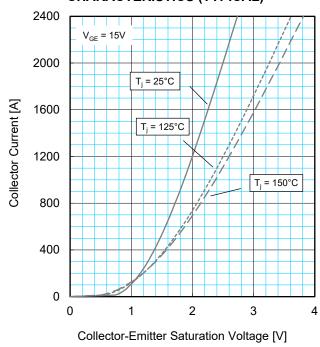
In case no PCB is used this maximum torque for M4 screw is 2.0 N·m.

PERFORMANCE CURVES

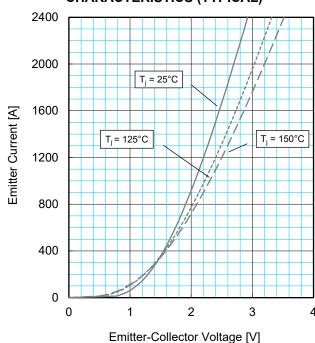




COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)

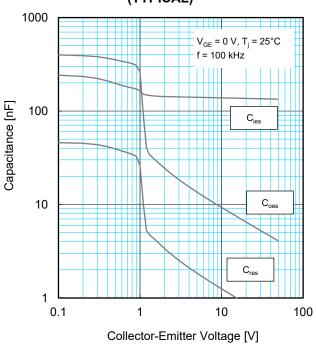


FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)

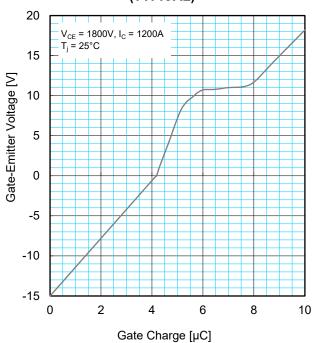


PERFORMANCE CURVES

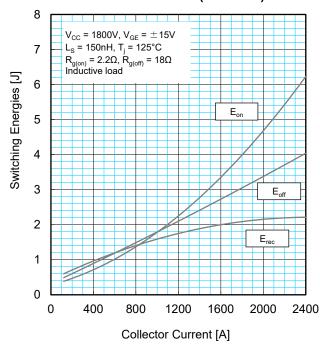
CAPACITANCE CHARACTERISTICS (TYPICAL)



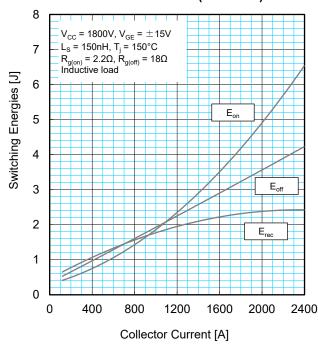
GATE CHARGE CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

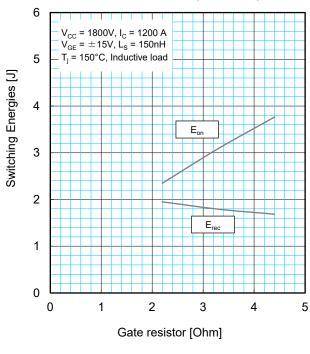


HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

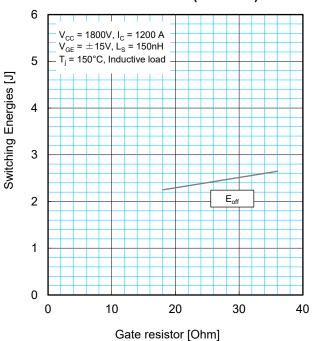


PERFORMANCE CURVES

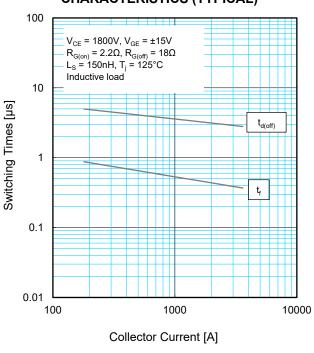
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



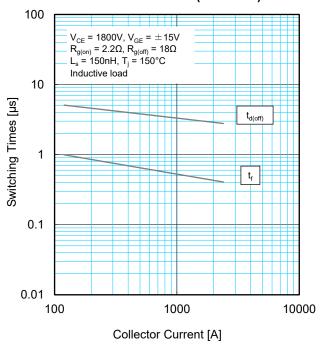
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)

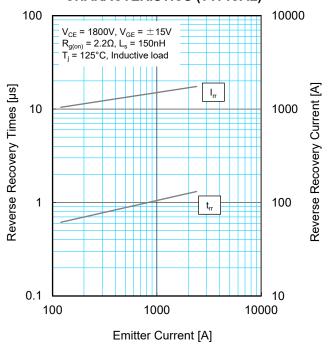


HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)

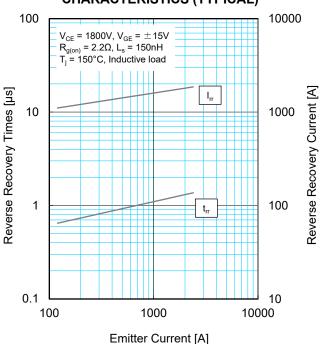


PERFORMANCE CURVES

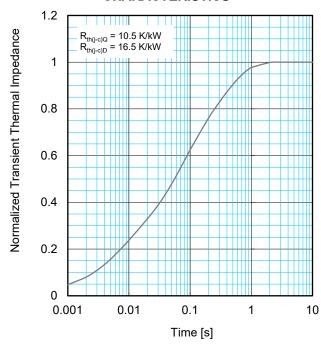
FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

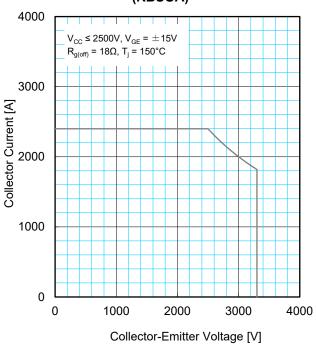


$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - \exp\left(\frac{t}{\tau_{i}}\right) \right\}$$

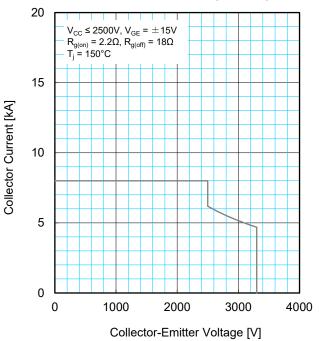
	1	2	3	4
R_i [K/kW]:	0.0096	0.1893	0.4044	0.3967
τ_i [sec]:	0.0001	0.0058	0.0602	0.3512

PERFORMANCE CURVES

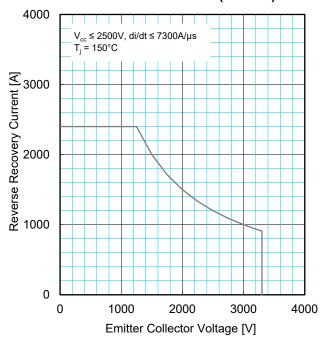
REVERSE BIAS SAFE OPERATING AREA (RBSOA)



SHORT CIRCUIT SAFE OPERATING AREA (SCSOA)



FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



5th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

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Dec. 2022 (HVM-1086-F)

5th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

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